

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of) Attorney Docket No.: MIYOSH0008
Seiichi AKAGI et al.)
) Confirmation No.: 6701
)
Serial No.: 10/598,515) Group Art Unit: 1796
)
Filed: September 1, 2006) Examiner: Hannah J. PAK
)
For: SEALANT EPOXY-RESIN MOLDING) Date: July 30, 2009
MATERIAL, AND ELECTRONIC)
COMPONENT DEVICE)

RESPONSE (C)

MAIL STOP: AMENDMENT
U.S. Patent and Trademark Office
Customer Service Window
Randolph Building
401 Dulany Street
Alexandria, VA 22314

Sir:

In response to the FINAL Office Action mailed March 30, 2009, and in view of the Request for Continued Examination (RCE) filed herewith, please enter the following remarks in the application identified above:

A Listing of Claims begins on page 2 of this paper.

Remarks/Arguments begin on page 10 of this paper.